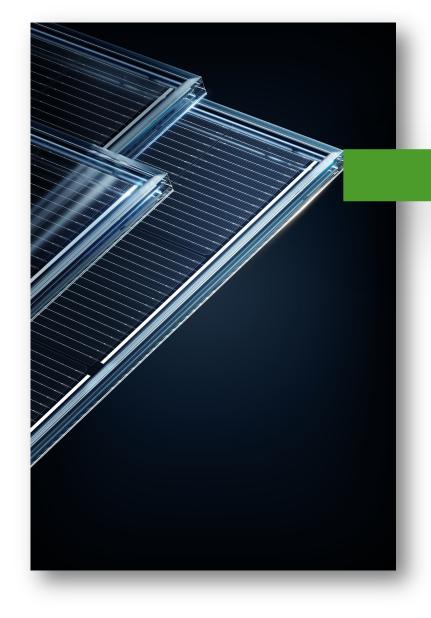


## Challenges & Experiences in Scaling up TOPCon n-Type Manufacturing

Johanna Bonilla Technical Product Manager Europe



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- 02 Technical Roadmap
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- 04 How to overcome challenges
- 05 Conclusions



### **Jinko Performance:**

## **Global Leader**

## 150GW

Delivered

\* 2023 Q1

## No.1

2016-2019 Module Shipments

25 World Records

110GW

Total Module Capacity \* 2023 Q4 **55GW** N-type Module Capacity \* 2023 Q4

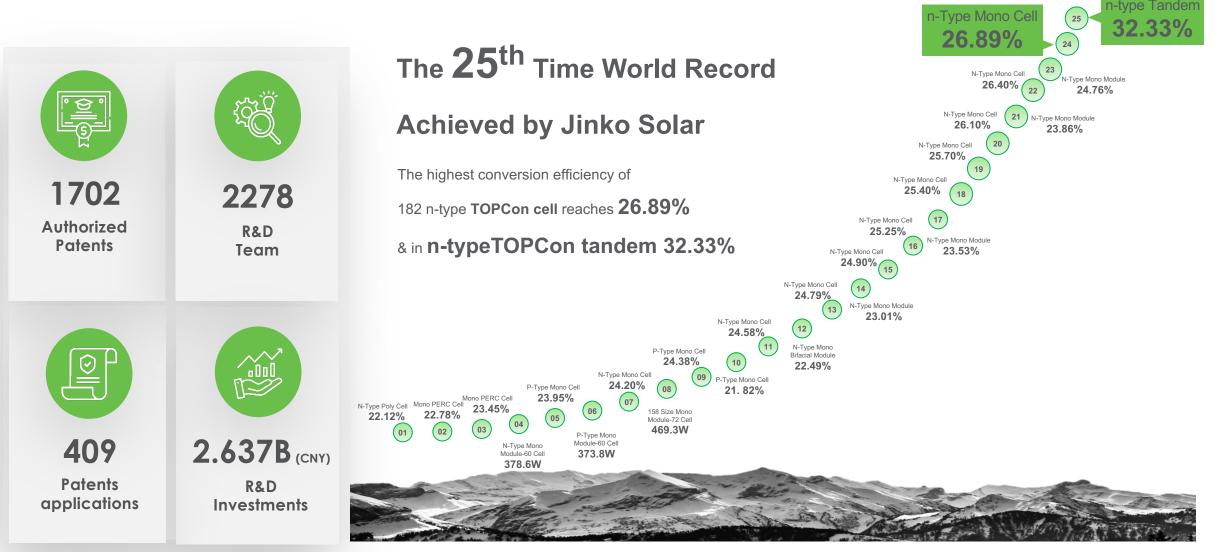
15%

Market Share

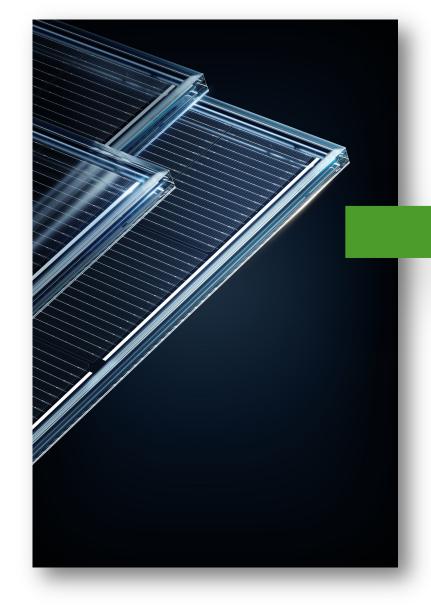
\* \*Data as of 2023 Q2

### **Global Leader in Technological Innovation**





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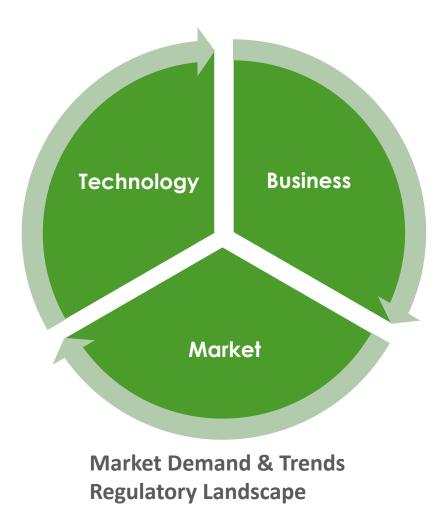
### Technical Roadmap: Why TOPCon?



**Higher Theoretical Limits**  $\eta = 28.7\%$  vs. Others<sup>[1,2]</sup>

Mass Production Viability Lowered delamination, hotspot, and moisture risks

Maturity & Compatibility PERC expierence

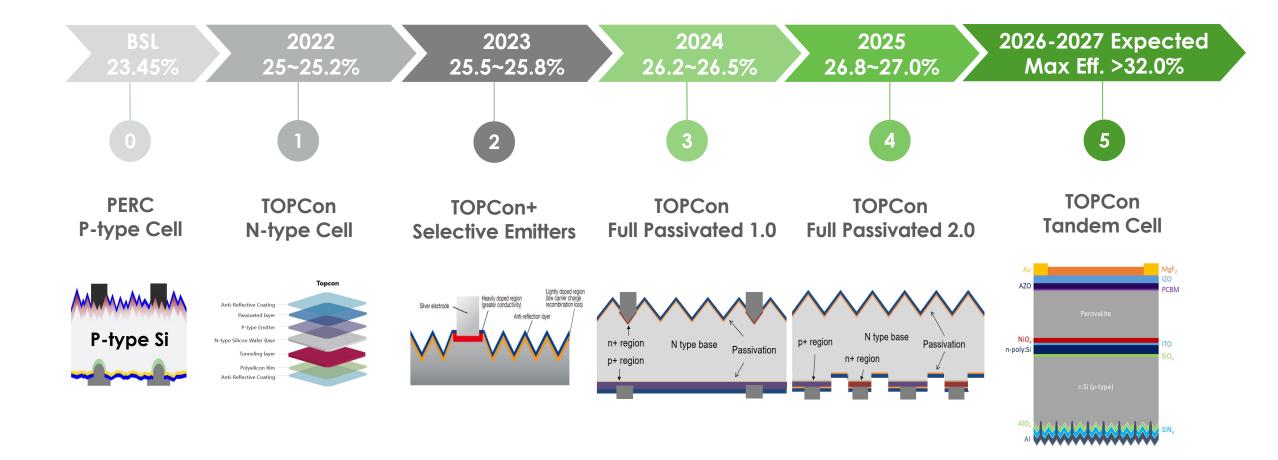


Costs Supply Chain Operational Efficiency

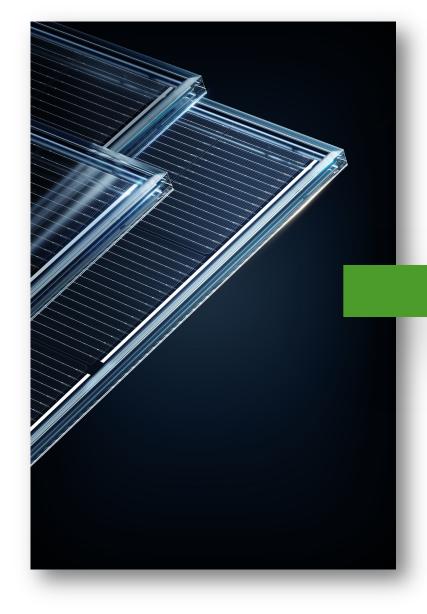
Brendel, R., Rienaecker, M. & Peibst, R. 2016, "A quantitative measure for the carrier selectivity of contacts to solar cells", Proc. 32nd EU PVSEC, Munich, Germany, doi:10.4229/EUPVSEC201620162C0.4.1.
 Brendel, R. & Peibst, R. 2016, "Contact selectivity and efficiency in crystalline silicon photovoltaics", IEEE J. Photovolt., Vol. 6, No. 6, pp.1413–1420, doi:10.1109/JPHOTOV.2016.2598267.

### **Technical Roadmap: Development trend**





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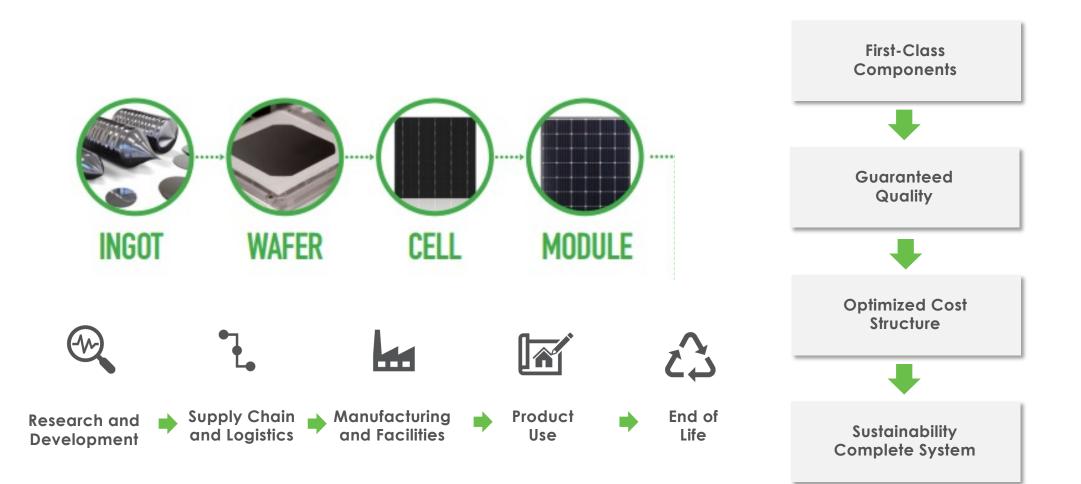


0.4	
03	Challenges in Production
02	Technical Roadmap
01	JinkoSolar Introduction

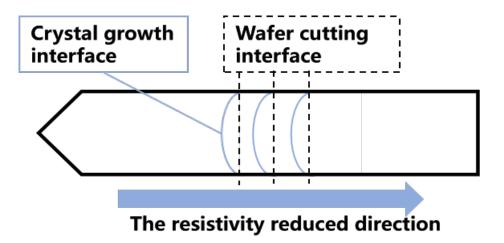
- 04 How to overcome challenges
- 05 Final conclusions

### **Vertically Integrated Production**





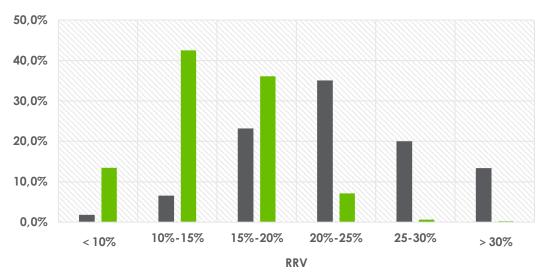
### Industrial challenges: Ingot –wafer- and final quality



- Uniform Growth: The solidification at the ingot growth interface is consistent, mantaining uniform resistivity
- Vertical Cutting Impact: Vertical wafer cutting introduces varied resistivity across different points on the wafer.
- Larger sizes, larger differences: he resistivity variation intensifies with larger wafer sizes
- **n-type vs.p-type:** due to the segregation coefficient difference, **n-type wafers are more uniform.**



#### **RRV** distribution of different doped types



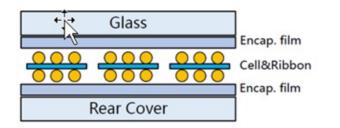
■P(Ga)-163.75 ■N-163.75

- The RRV (radial resistivity variation) value of the P type wafers with Ga doped is higher than the N type wafers with P doped.
- As the wafer size increases further, RRV challenge for p-type is more severe than n-type.

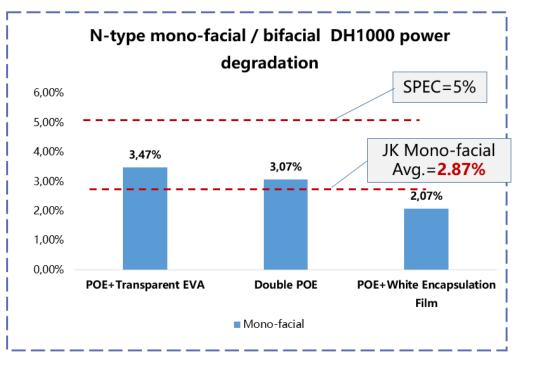
### Industrial challenges: BOM selection- Encapsulant



#### n-Module Encap. Trend



	EVA	POE
Manufacturing difficulty	*	**
Curing Speed	***	**
Adhesion to Glass	***	**
Reliability	***	***
Anti PID	**	***
WVTR	*	**
Cost	**	***



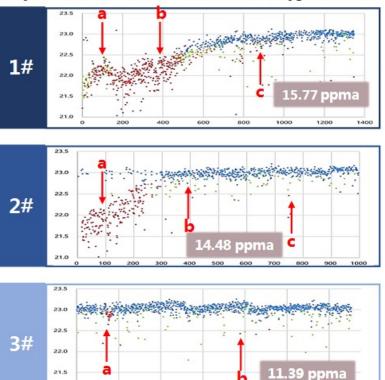
- Supply chain: Cost & reliability
- Feasibility: implementation at mass scale production
- Continuous improvement on-going materials/processes



### Industrial challenges: n-type wafer EL "ring" effect

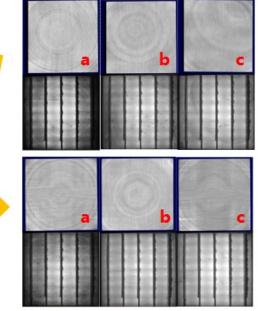
- Ring effects under EL is a wellknown phenomena for n-type, with <u>no impact in power</u>.
- <u>Strong correlation with the</u> <u>oxygen concentration in</u> <u>wafers</u>; oxygen precipitation.
- While low oxygen ingot growth technology developing, product performance study and new standards are widely discussed.

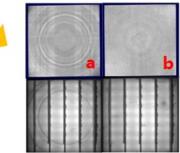
Verification of sequential wafers with black ring at the head of monocrystalline silicon rod with different initial oxygen content



1200

PL of wafer and EL of cell with black rings at different positions



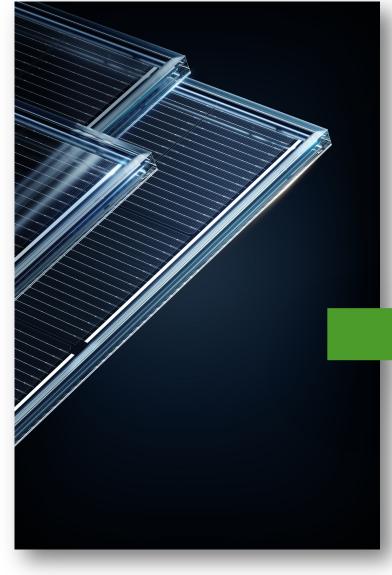


#### IEC working groups for EL defects on TopCon: WG8 for Cells & WG2 for module

21.0

200

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on

# Strategies for Success: In-depth grasp of critical parameters



Well equipped R&D center enables comprehensive analysis & investigation



#### **Device Analysis**

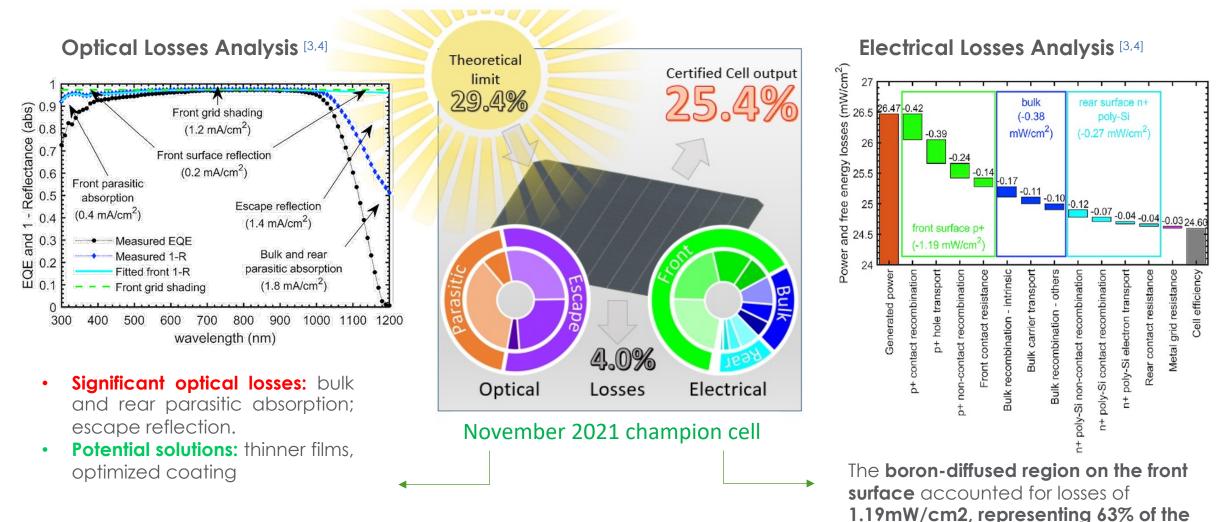
**Passivation** system : lifetime, PL, EL,  $J_0$ 

**Optical system:** film design, shading, EQE

**Electrical:** TLM, Rs mapping, pFF analysis

# Strategies for Success: In-depth grasp of critical parameters



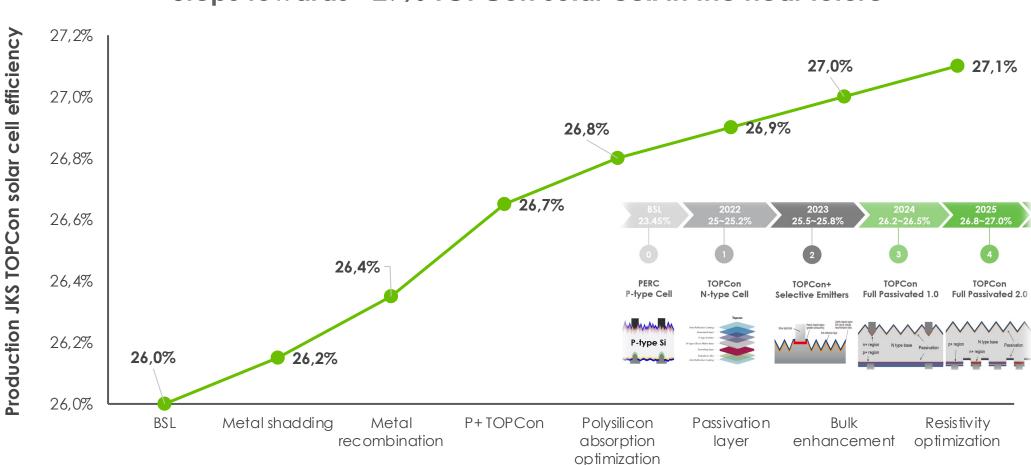


[3] Zheng P, Yang J, Wang Z, et al., "Detailed loss analysis of 24.8% large-area screen-printed n-type solar cell with polysilicon passivating contact," Cell Reports Physical Science 2, vol. 100603, October 20, 2021, doi: 10.1016/j.xcrp.2021.100603.

[4] Bonilla J, Giehl R, Magistris C and Murgioni R. TOPCon efficiency breakthrough from cell to PV modules. Photovolatics International Ed. 48

total losses

### Strategies for Success: Practical path

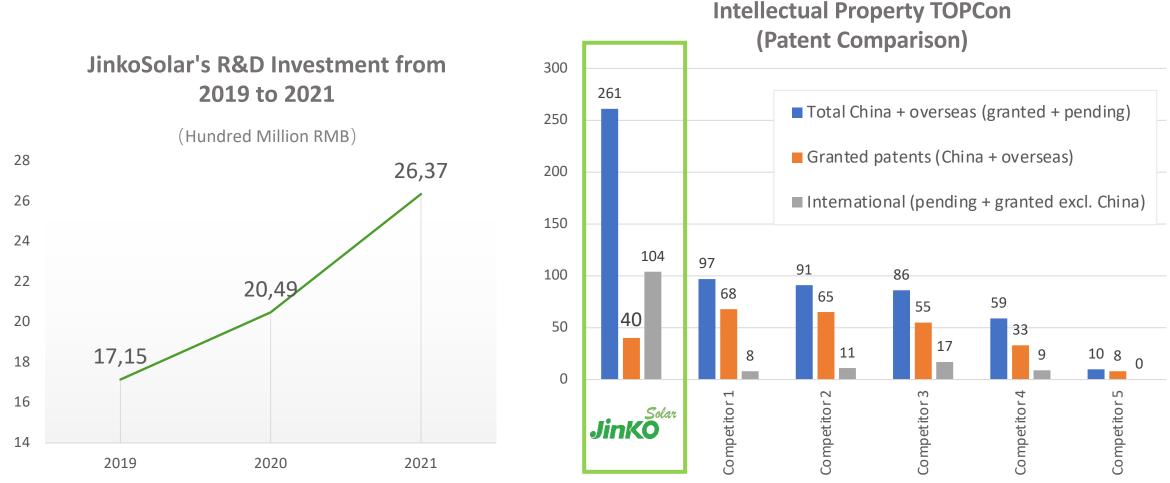


#### Steps towards >27% TOPCon solar cell in the near future



### Strategies for Success: R&D Investment and Patent Forging



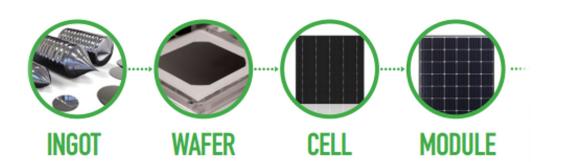


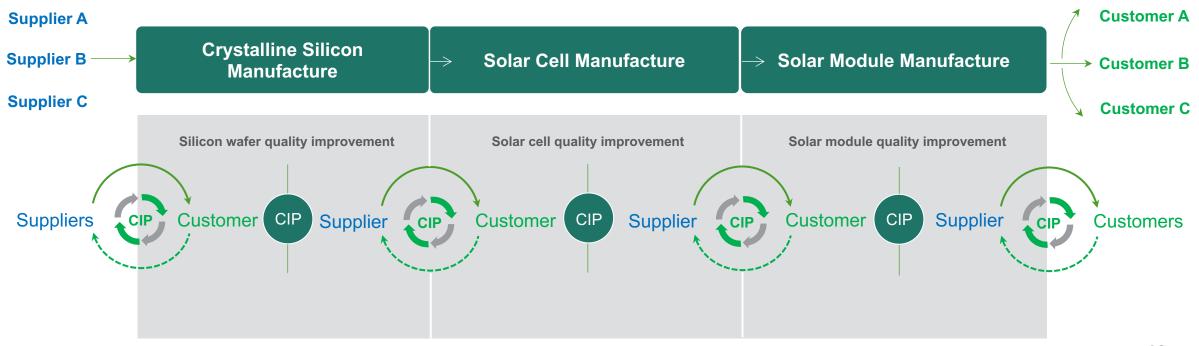
Source: before 2023/11 based on PatSnape public database..

### Strategies for Success: Production Quality & Quality Assurance



- Rigorous control over suppliers, production processes, and customer satisfaction
- Strong interaction between key departments (R&D, QA and Production)
- Pilot lines before mass production



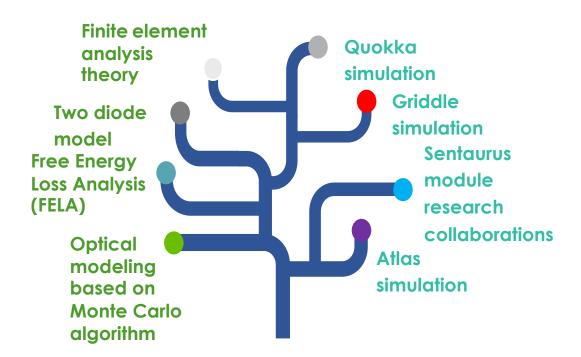


### Strategies for Success: Data & More Data



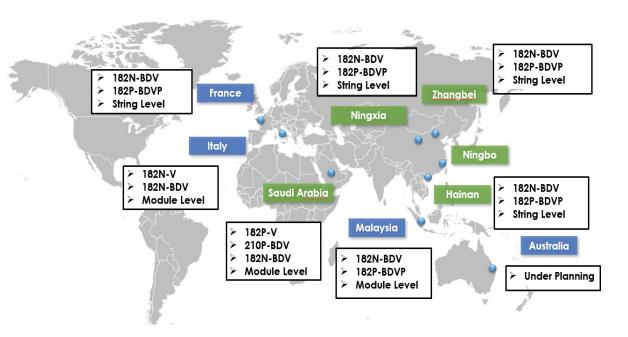
### Strong R&D

fundamental research & simulation



### Worldwide Field Tests

#### Energy yield & long-term performance



### Strategies for Success: Testing & more testing

LOP PERFORME

PVELkiwa

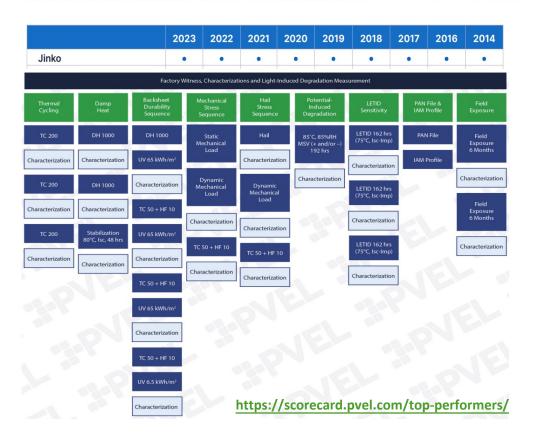
**PV MODULE** 

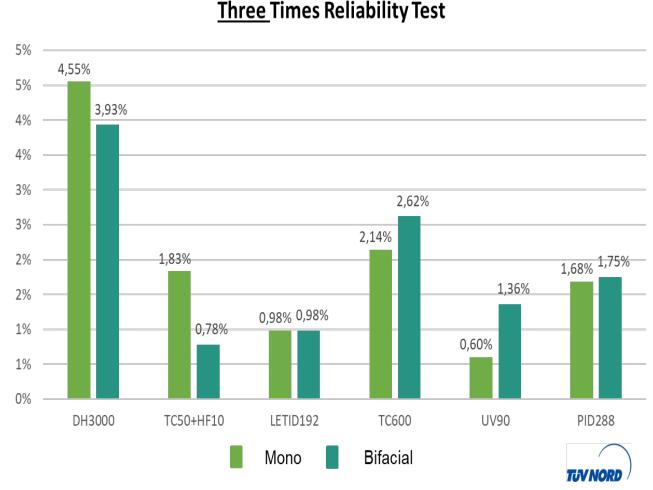
RELIABILITY SCORECARD



#### **Historical Scorecard**

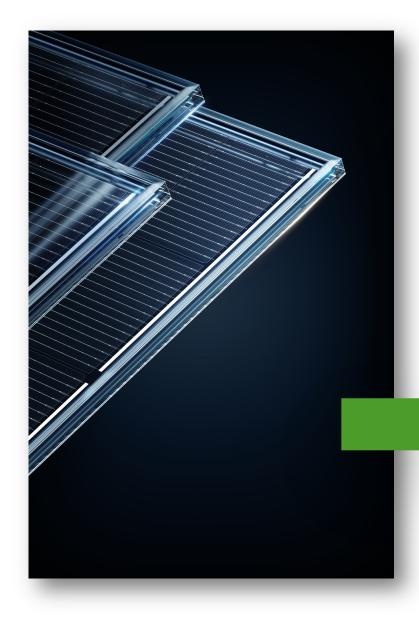
The table below shows the history of top performance for all manufacturers featured in the 2023 Scorecard. Manufacturers are listed by the number of years they have been designated a Top Performer, in alphabetical order.





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### **Conclusions: JinkoSolar and TOPCon**



#### > Foundation in R&D:

- Robust cornerstone before product launches.
- Proactive measures are taken to address potential issues and ensure seamless integration.

#### > Continuous Learning Process:

- Mass production involves a learning process.
- Correction is acknowledged as part of the process, but emphasis on proactive quality check & prevention.

#### Committed decisions:

• Decision driven by data, test and long-term realistic goals

#### Readiness and Resilience:

• Challenges require mitigation, innovation and dedications to quality.



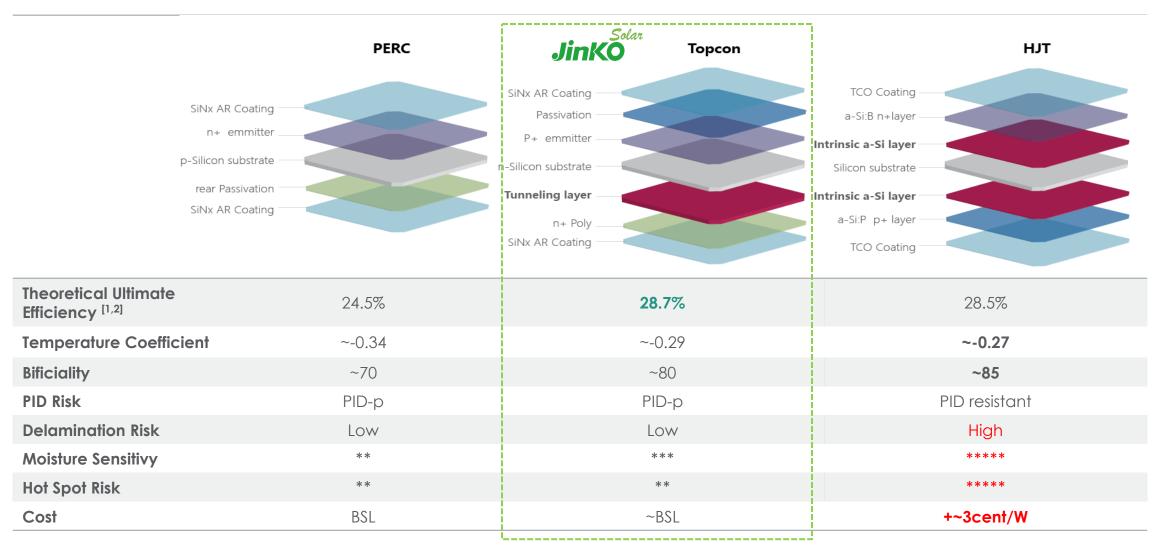
# Thank you!

#### Johanna Bonilla

Technical Product Manager Europe

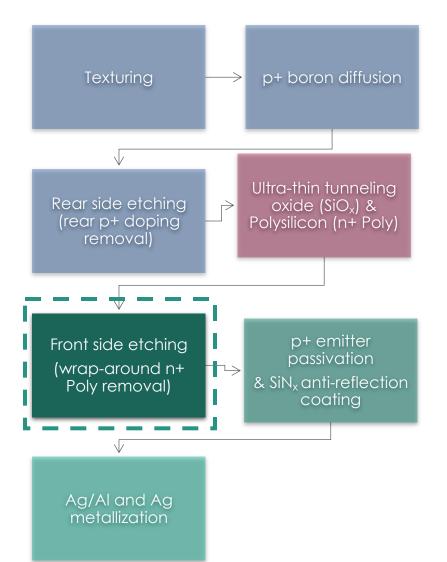
### Technical Roadmap: Why TOPCon?





[1] Brendel, R., Rienaecker, M. & Peibst, R. 2016, "A quantitative measure for the carrier selectivity of contacts to solar cells", Proc. 32nd EU PVSEC, Munich, Germany, doi:10.4229/EUPVSEC201620162C0.4.1. [2] Brendel, R. & Peibst, R. 2016, "Contact selectivity and efficiency in crystalline silicon photovoltaics", IEEE J. Photovolt., Vol. 6, No. 6, pp.1413–1420, doi:10.1109/JPHOTOV.2016.2598267.

### Industrial challenges: Cell process Wrap-around n+ poly removal



Removal: Since polysilicon is inherently deposited on both sides of the wafer, a wrap-around etching using mass production feasible chemical wet-bench is performed. Using appropriate process control, the front side p+ emitter can be well protected

#### Before







The front side borosilicate glass (BSG) and the rear side phosphosilicate glass (PSG) layers are removed in diluted HF solution

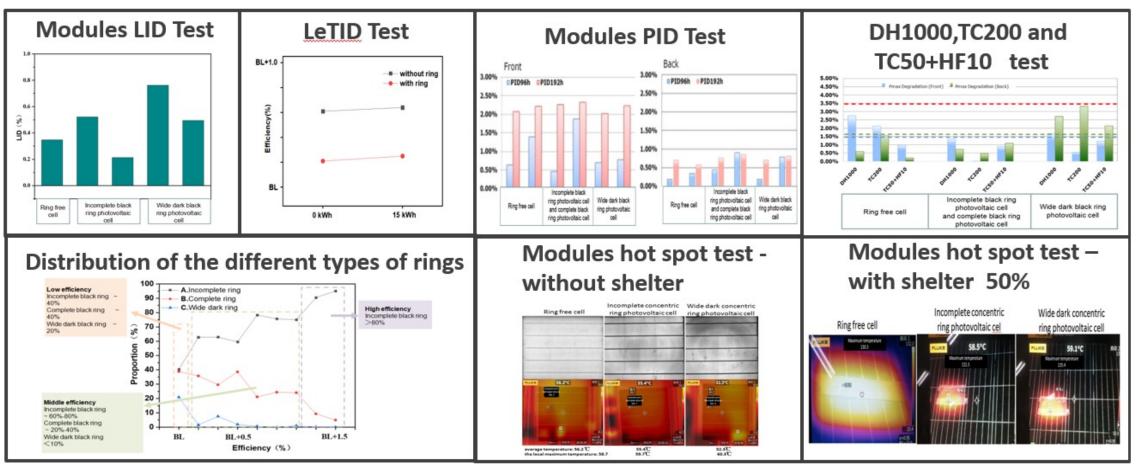
Solar

**JinKO** 



### Industrial challenges: n-type wafer EL "ring" effect

Various performance comparison study between cells with and without ring effects demonstrate **no clear correlation between rings effects with degradation problems.** 

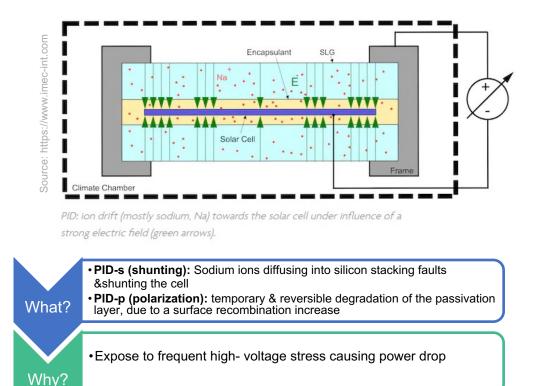


IEC working groups for EL defects on TopCon: WG8 for Cells & WG2 for module

### Tiger Neo Utility — Enhanced reliability

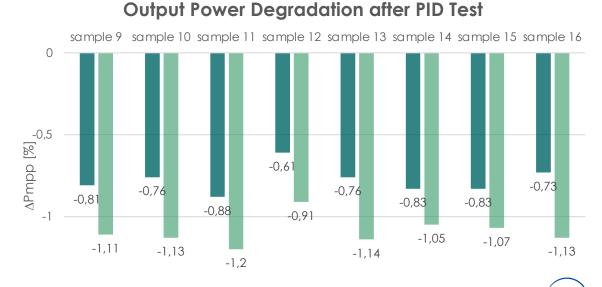


#### Potential-Induced Degradation (PID)



PID-p senstivity
Bifacial cells in glass/glass are more sensitive
Thinner layers also seem to be more sensitive

#### PID 3<sup>rd</sup> party results for JKS Dual Glass Modules



-1,5 \_\_\_\_\_

#### Module type: JKM550N-72HL4-BDV

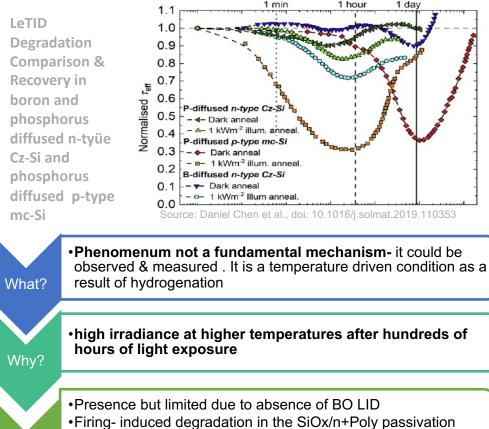
∆Pmpp [%]	After 96h	After 192h
Min	-0,61%	-0,91%
Max	-0,88%	-1,20%
Average	-0,78%	-1,09%

**TJV NOR** 

### **Tiger Neo Utility** — Enhanced reliability



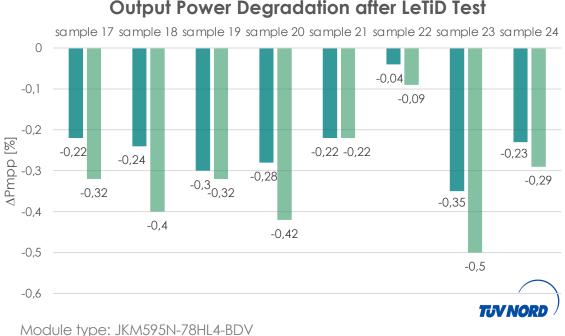
#### Light and elevated Temperature-Induced Degradation (LeTID)



•Hydrogenation- critical for chemical passivation for SiOx/n+Poly

TOPCon

#### LeTID 3<sup>rd</sup> party results for JKS Dual Glass Modules



After 300h

-0.38%

-0,45%

-0,42%

**∆Pmpp** [%]

Min

Max

**Average** 

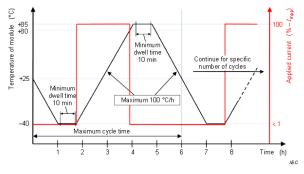
#### **Output Power Degradation after LeTiD Test**

28

### Tiger Neo Utility – Enhanced reliability



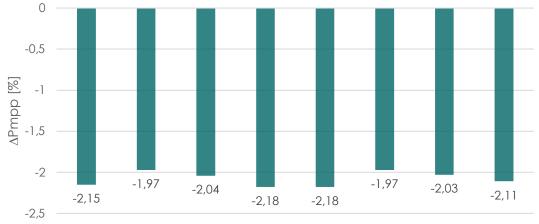
#### Thermal Cycling (TC)-400



Module type: JKM550N-72HL4-BDV				
<b>∆Pmpp [%]</b>	After 400 cycles			
Min	-0,38%			
Max	-0,45%			
Average	-0,42%			

#### Output Power Degradation after TC400 testing TONNORD

sample 33 sample 34 sample 35 sample 36 sample 37 sample 38 sample 39 sample 40



#### Damp Heat (DH)-2000

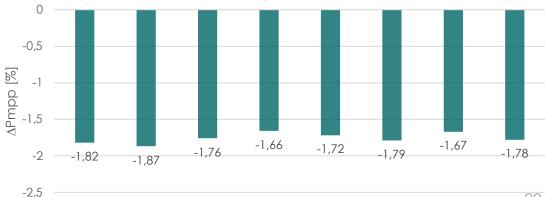


Module type: JKM550N-72HL4-BDV

<b>∆Pmpp [%]</b>	After 2000h
Min	-0,38%
Мах	-0,45%
Average	-0,42%

Output Power Degradation after DH2000 TUNNORD

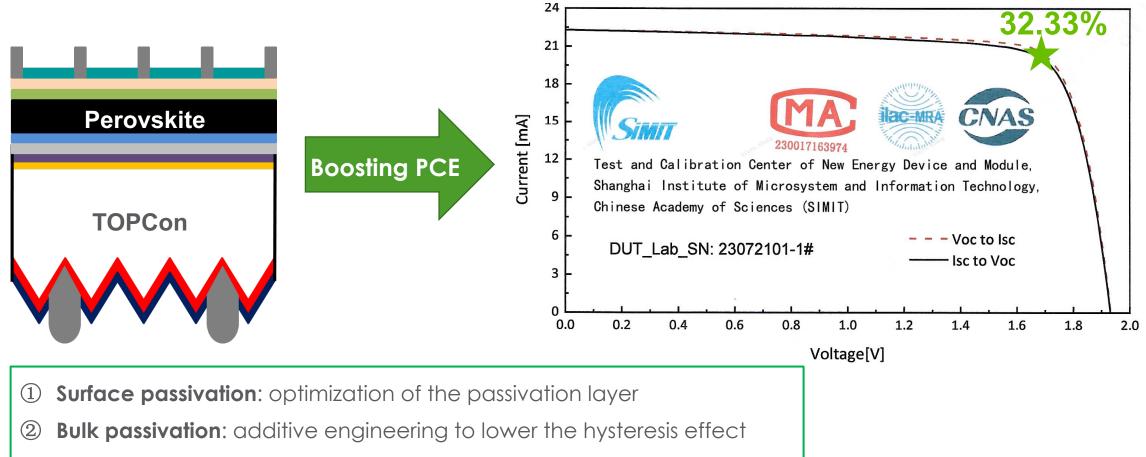
sample 41 sample 42 sample 43 sample 44 sample 45 sample 46 sample 47 sample 48



### **Technical Roadmap: Development trend**



JinkoSolar's New Cell Efficiency Record of 32.33% achieved on perovskite/TOPCon tandem



③ Recombination layer optimization: high quality TCO with low resistance